

TECHNICAL DATA DATA SHEET 229, REV. A

HERMETIC POWER MOSFET N-CHANNEL

FEATURES:

- 1000 Volt, 2.0 Ohm, 6.0A MOSFET
- Isolated Hermetic Metal Package
- Fast Switching
- Low R_{DS (on)}

MAXIMUM RATINGS

ALL RATINGS ARE AT $T_{\rm C}$ = 25°C UNLESS OTHERWISE SPECIFIED.

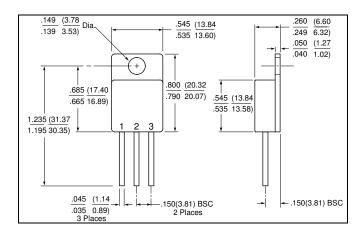
RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	V_{GS}	-	-	±20	Volts
ON-STATE DRAIN CURRENT	I _D	-	-	6.0	Amps
PULSED DRAIN CURRENT	I _{DM}	-	-	24	Amps
OPERATING AND STORAGE TEMPERATURE	T _J /T _{STG}	-55	-	+150	°C
TOTAL DEVICE DISSIPATION	P _D	-	-	150	Watts

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNITS
DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV _{DSS}	1000	-	-	Volts
$V_{GS} = 0V, I_D = 3.0 \text{ mA}$					
STATIC DRAIN TO SOURCE ON STATE RESISTANCE		-	-	2.0	
$V_{GS} = 10V, I_D = 3.0A$	R _{DS(ON)}				Ω
GATE THRESHOLD VOLTAGE $V_{DS} = V_{GS}$, $I_D = 2.5 \text{mA}$	$V_{GS(th)}$	2.0	-	4.5	Volts
FORWARD TRANSCONDUCTANCE	g fs	4.0	6.0		$S(1/\Omega)$
$V_{DS} = 10V, I_{D} = 3.0A$				-	
ZERO GATE VOLTAGE DRAIN CURRENT					
$V_{DS} = 0.8 \text{ x Max. rating}, V_{GS} = 0V, T_{J} = 25^{\circ}C$	I _{DSS}	-	-	250	μΑ
$T_J = 125$ °C				1000	
GATE TO SOURCE LEAKAGE FORWARD $V_{GS} = 20V$	I_{GSS}	-	-	100	nA
GATE TO SOURCE LEAKAGE REVERSE $V_{GS} = -20V$				-100	
TURN ON DELAY TIME $V_{DD} = 500V$,	$t_{d(ON)}$	-	35		
RISE TIME $I_D = 3.0A$	t_r		40		nsec
TURN OFF DELAY TIME V _{GS} =10V	t _{d(OFF)}		100		
FALL TIME $R_G = 4.7\Omega$	t _f		60		
DIODE FORWARD VOLTAGE $I_S = 6.0A, V_{GS} = 0V$	V_{SD}	-	-	1.5	Volts
Pulse test, $t \le 300 \mu s$, duty cycle $d \le 2 \%$					
REVERSE RECOVERY TIME $T_J = 25^{\circ}C$,					
$IF=6.0A, V_{DD}=100V$	t _{rr}	-	-	250	nsec
di/dt = 100A/μsec					
INPUT CAPACITANCE $V_{GS} = 0 \text{ V}$	C _{iss}	-	2600	-	
OUTPUT CAPACITANCE $V_{DS} = 25 \text{ V}$	Coss		180		рF
REVERSE TRANSFER CAPACITANCE f = 1.0MHz	C_{rss}		45		
THERMAL RESISTANCE, JUNCTION TO CASE	R_{thJC}	-	-	0.83	°C/W

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MECHANICAL DIMENSIONS: in Inches / mm



TO-254

DEVICE TYPE	PIN-1	PIN-2	PIN-3
N-CHANNEL MOSFET	DRAIN	SOURCE	GATE
TO-254 PACKAGE			



TECHNICAL DATA

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